

*updated*

## Freeform Search

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**Database:** US Pre-Grant Publication Full-Text Database  
US Patents Full-Text Database  
US OCR Full-Text Database  
EPO Abstracts Database  
JPO Abstracts Database  
Derwent World Patents Index  
IBM Technical Disclosure Bulletins

**Term:** L8 and (substrate)

**Display:** 10 **Documents in Display Format:** - **Starting with Number** 1

**Generate:** ☐ Hit List ☒ Hit Count ☐ Side by Side ☐ Image

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Search

Clear

Interrupt

## Search History

**DATE:** Friday, September 15, 2006    [Purge Queries](#)    [Printable Copy](#)    [Create Case](#)

Set Name Query

side by side

Hit Count Set Name

result set

*DB=PGPB,USPT,USOC,EPAB,JPAB; PLUR=YES; OP=ADJ*

<u>L11</u>	L8 and (substrate)	448	<u>L11</u>
<u>L10</u>	L8 and (flexible near circuit board or flexible near substrate)	21	<u>L10</u>
<u>L9</u>	L8 and (circuit board)	206	<u>L9</u>
<u>L8</u>	L6 and (insulat\$4 or isolat\$4)	1680	<u>L8</u>
<u>L7</u>	L6 and (insulat\$3 or isolat\$3)	1677	<u>L7</u>
<u>L6</u>	L5 and (temperature or thermal)	2538	<u>L6</u>
<u>L5</u>	L4 and (resist\$4)	2602	<u>L5</u>
<u>L4</u>	L3 and (conduct\$3)	3069	<u>L4</u>
<u>L3</u>	(338/22R,28,25;374/144,185,163,45,183)![CCLS]	7033	<u>L3</u>

*DB=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ*

<u>L2</u>	L1 and (HVAC or air condition\$3)	18	<u>L2</u>
<u>L1</u>	valve body near temperature	259	<u>L1</u>

END OF SEARCH HISTORY